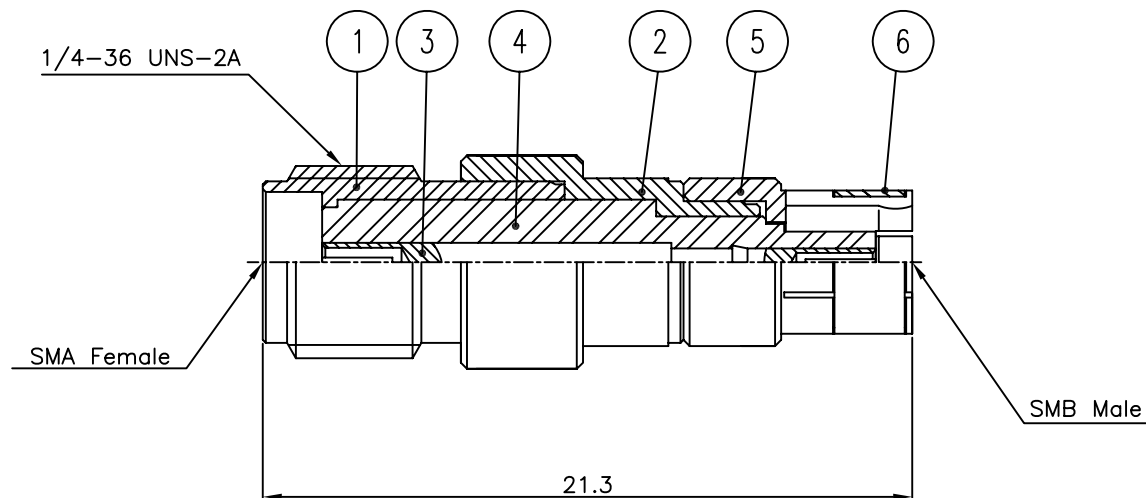


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2019.08.22.



6	SPRING RING	1	BeCu C17300	Copper Plate	DSR00009-5/1
5	JACK	1	MBsBD C3604BD-F	Gold Plate	DJA00091-5/1
4	INSULATOR	1	TEFLON		DAI00057-N/1
3	CONTACT	1	BeCu C17300	Gold Plate	DAC00095-5/1
2	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD02132-5/1
1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD01709-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ± 0.1	DATE 2019. 08. 22.		 KJ COMTECH CO.,LTD. RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle $\pm 1^\circ$	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		TITLE SMA50 (J) SMB50 (P) ST
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	5/1	
		UNIT	mm	
		DWG NO.	AD00370-7/4	REVISION I R SHEET 1 of 1